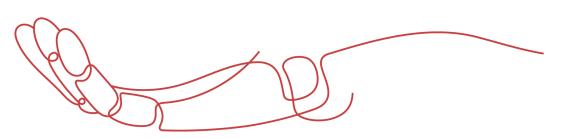




PRODUCT DATA SHEET



To learn more about JGSEMI, please visit our website at







Datasheet

urces Samples

Please note: Please check the JINGAO Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.jg-semi.cn. Please email any questions regarding the system integration to JINGAO_questions@jgsemi.com.



TRANSISTOR(NPN)

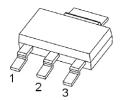
FEATURES

Power dissipation

MAXIMUM RATINGS (Ta=25℃ unless otherwise noted)

Symbol	Parameter	Value	Unit	
V _{CBO}	Collector-Base Voltage	50	V	
V _{CEO}	Collector-Emitter Voltage	40	V	
V _{EBO}	Emitter-Base Voltage	6	V	
Ic	Collector Current -Continuous	3	Α	
Pc	Collector Power Dissipation	0.5	W	
R _{OJA}	Thermal Resistance from AAA Junction to Ambient	Á25€	°C/W	
Rejc	Thermal Resistance from ÁÁÁ Junction to Case	Á35	°C/W	
T _J ,T _{stg}	Operation Junction and Storage Temperature Range	-55~150	$^{\circ}$	

SOT-223



1. BA

2. C LECTOR

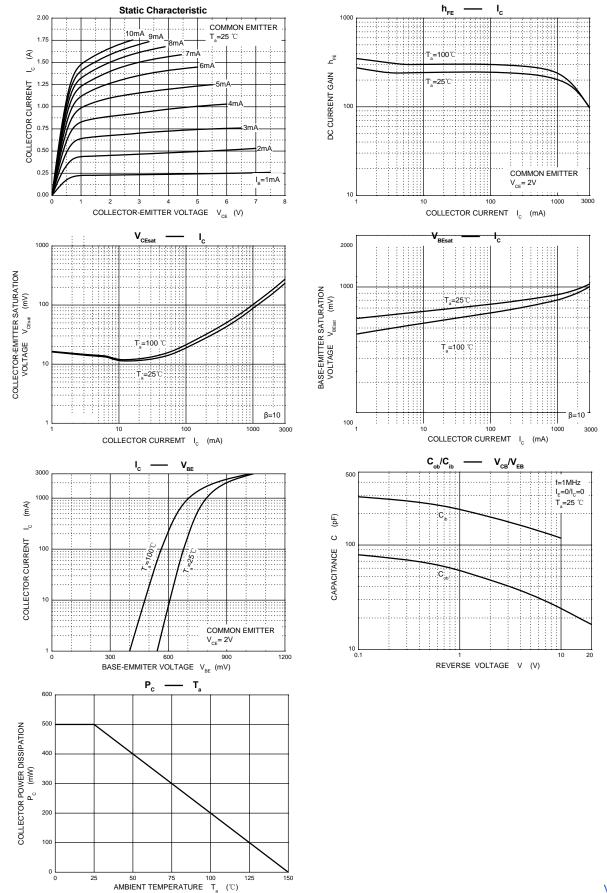
3. EMITT

ELECTRICAL CHARACTERISTICS(Ta=25°C unless otherwise specified)

Parameter	Symbol	Test conditions	Min	Тур	Max	Unit
Collector-base breakdown voltage	V _{(BR)CBO}	$I_C = 100 \mu A, I_E=0$	50			V
Collector-emitter breakdown voltage	V _{(BR)CEO}	$I_{C} = 10 \text{mA}, I_{B} = 0$	40			V
Emitter-base breakdown voltage	V _{(BR)EBO}	I _E = 100μA, I _C =0	6			V
Collector cut-off current	I _{CBO}	V _{CB} = 40V, I _E =0			1	μA
Collector cut-off current	I _{CEO}	V _{CE} = 30V, I _B =0			10	μΑ
Emitter cut-off current	I _{EBO}	V _{EB} = 6V, I _C =0			1	μΑ
DC gurrent gain	h _{FE(1)}	V _{CE} =2V, I _C = 1A	60		400	
DC current gain	h _{FE(2)}	V _{CE} =2V, I _C = 100mA	32			
Collector-emitter saturation voltage	V _{CE(sat)}	I _C = 2A, I _B = 0.2 A			0.5	V
Base-emitter saturation voltage	V _{BE(sat)}	I _C = 2A, I _B = 0.2 A			1.5	V
Transition frequency	f⊤	V _{CE} = 5V , Ic=0.1A f =10MHz	50			MHz

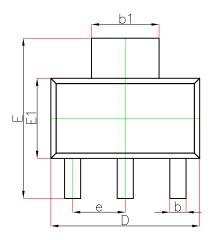


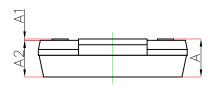
Typical Characteristics

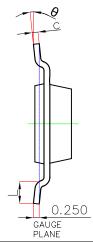




SOT-223 Package Outline Dimensions

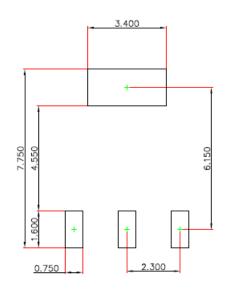






Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min.	Max.	Min.	Max.	
Α		1.800		0.071	
A1	0.020	0.100	0.001	0.004	
A2	1.500	1.700	0.059	0.067	
b	0.660	0.840	0.026	0.033	
b1	2.900	3.100	0.114	0.122	
С	0.230	0.350	0.009	0.014	
D	6.300	6.700	0.248	0.264	
E	6.700	7.300	0.264	0.287	
E1	3.300	3.700	0.130	0.146	
е	2.300(BSC)		0.091(BSC)		
L	0.750		0.030		
θ	0°	10°	0°	10°	

SOT-223 Suggested Pad Layout



Note:

- 1.Controlling dimension:in millimeters.
- 2.General tolerance:±0.050mm.
- $3. \\ \mbox{The pad layout is for reference purposes only.}$



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